

N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^d	Q _g (Typ.)			
40	0.012 at $V_{GS} = 10 \text{ V}$	12	15 nC			
	0.012 at V _{GS} = 4.5 V	9	15110			

SO-8 S 1 8 D S 2 7 D S 3 6 D Top View

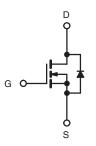
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- 100 % UIS Tested
- Compliant to RoHS directive 2002/95/EC



APPLICATIONS

- Synchronous Rectification
- POL, IBC
 - Secondary Side



N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	40	V		
Gate-Source Voltage	V _{GS}	± 20			
	T _C = 25 °C		12		
Continuous Drain Current (T _{.I} = 150 °C)	T _C = 70 °C		8		
Continuous Diain Current (1, = 150°C)	T _A = 25 °C	- I _D	12.4 ^{a, b}	Α	
	T _A = 70 °C		8.8 ^{a, b}	^	
Pulsed Drain Current		I _{DM}	50		
Avalanche Current L = 0.1 mH		I _{AS}	15		
Avalanche Energy	L = 0.111111	E _{AS}	11	mJ	
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	5	A	
	T _A = 25 °C		2.1 ^{a, b}	^	
	T _C = 25 °C		6		
Maximum Power Dissipation	T _C = 70 °C	D.	3.8	w	
	T _A = 25 °C	P _D	2.5 ^{a, b}	VV	
	T _A = 70 °C		1.6 ^{a, b}		
Operating Junction and Storage Temperature	T _J , T _{stq}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{a, c}	t ≤ 10 s	R_{thJA}	37	50	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	17	21			

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under Steady State conditions is 85 °C/W.
- d. Based on $T_C = 25$ °C.



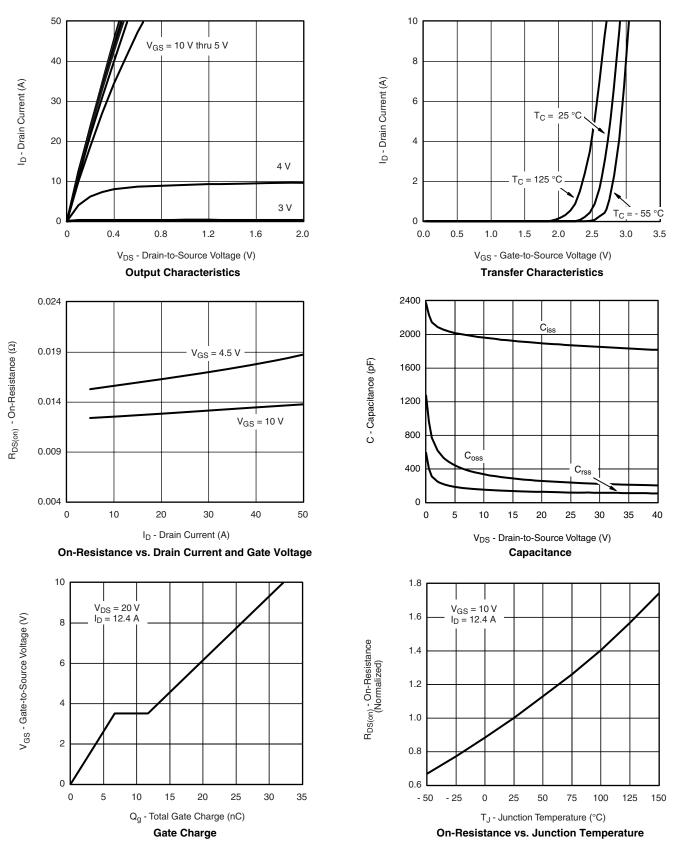
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static					l		
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V, I}_{D} = 250 \mu\text{A}$	40			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L = 250 uA		40		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 6			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	1		3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zana Oaka Walkana Buain Oamani	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V			1	μΑ	
Zero Gate Voltage Drain Current		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α	
Due to Course On Otata Due talance a		V _{GS} = 10 V, I _D = 12.4 A		0.010			
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 10.8 \text{ A}$		0.012		Ω	
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 12.4 A		56		S	
Dynamic ^b				'		,	
Input Capacitance	C _{iss}			2000			
Output Capacitance	C _{oss}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		260		pF	
Reverse Transfer Capacitance	C _{rss}			150			
Total Gate Charge		V _{DS} = 10 V, V _{GS} = 10 V, I _D = 12.4 A		33	50		
	Q _g			15	23	nC	
Gate-Source Charge	Q_{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 12.4 \text{ A}$		6.7			
Gate-Drain Charge	Q_{gd}			5.1			
Gate Resistance	R_{g}	f = 1 MHz		1.4	2.1	Ω	
Turn-On Delay Time	t _{d(on)}			25	40		
Rise Time	t _r	V_{DD} = 20 V, R_L = 2 Ω		12	20		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ 10 A, V_{GEN} = 4.5 V, R_g = 1 Ω		25	40		
Fall Time	t _f			10	15		
Turn-On Delay Time	t _{d(on)}			10	15	ns	
Rise Time	t _r	V_{DD} = 20 V, R_L = 2 Ω		15	25	- - -	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		30	45		
Fall Time	t _f			10	15		
Drain-Source Body Diode Characteristi	cs			<u> </u>		l	
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			30		
Pulse Diode Forward Current	I _{SM}				50	Α	
Body Diode Voltage	V_{SD}	$I_S = 10 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	٧	
Body Diode Reverse Recovery Time	t _{rr}			30	60	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 10 A, dl/dt = 100 A/μs, T _J = 25 °C		26	52	nC	
Reverse Recovery Fall Time	t _a			17.5			
Reverse Recovery Rise Time	t _b			12.5		ns	

Notes

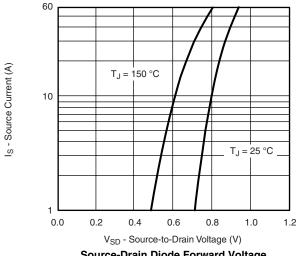
- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

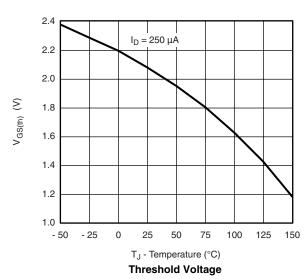






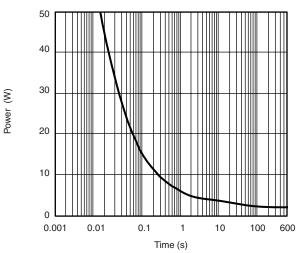




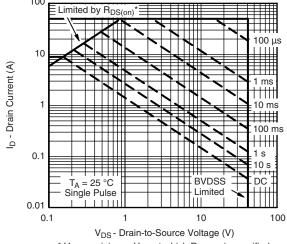


0.030 $I_D = 12.4 A$ 0.025 $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}\,$ - On-Resistance (Ω) 0.020 125 °C 0.015 0.010 25 °C 0.005 0.000 0 10 V_{GS} - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage



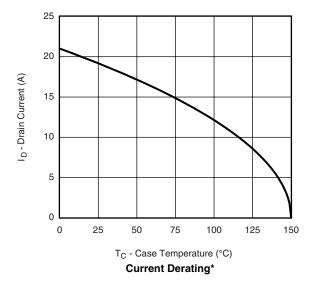
Single Pulse Power (Junction-to-Ambient)

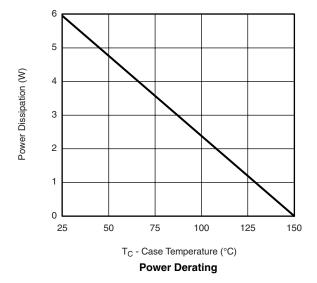


* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

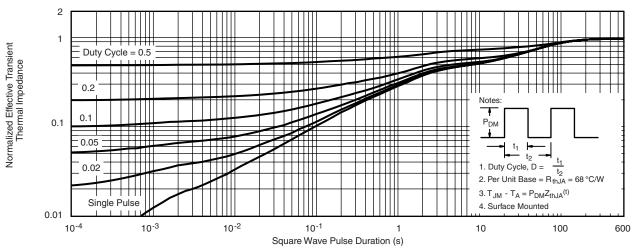




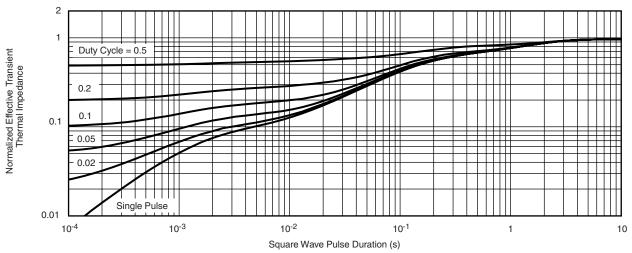


^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





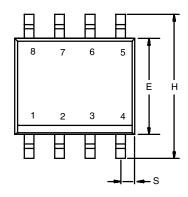
Normalized Thermal Transient Impedance, Junction-to-Ambient

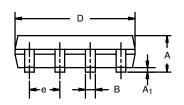


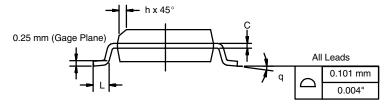
Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





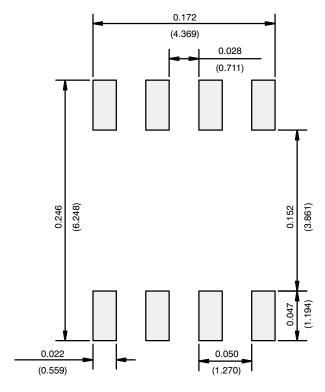


	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-065	27-Rev. I, 11-Sep-0	6	•			

DWG: 5498



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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